The University of Western Ontario
Department of Physics and Astronomy

P9826b Winter 2013

## March 13, 2013

## Homework Assignment \#1 (due on March 25, 2013)

## Problems:

1. (3 points) XPS spectrum for unknown sample is presented below with exact binding energies list. Identify the peaks (element and transition) at the listed binding energy positions.

## B.E. Peak

1071.9 978.8 -
763.2 718.4 644.2 604.3 573.5 546.9 532.9 497.2 374.7 368.4 -
353.7 -
335.5 -
285.6 -
269.7 -


SURFACE SCIENCE WESTERN
198.3 -
150.7 -
99.6 -
88.4 -
84.1 -

|  | 1 | 2 | 3 | 4 | 5 | Total |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| mark |  |  |  |  |  |  |
| out of | 3 | 4 | 3 | 2 | 3 | 15 |

2. (4 points) In Rutherford backscattering spectrometry, the kinematics of the collisions and the scattering cross section are independent of the chemical bonding, but only dependent on the masses of the target atoms. The diagram of the collision events is shown below:


In the collision, energy is transferred from the moving particle to the stationary target atom; the reduction in energy of the scattered particle depends on the masses of incident and target atoms and provides the signatures of the target atoms.
Assuming that an incident energetic particle of mass $\mathrm{M}_{1}$ has velocity $\mathrm{v}_{0}$ and energy $\mathrm{E}_{0}$, and target atom of mass $\mathrm{M}_{2}$ is at rest. After the collision, the values of the velocities $v_{1}$ and $v_{2}$, the projectile and target atoms are determined by the scattering angle $\theta$ and recoil angle $\phi$.

One can write equations for conservation of energy, and conservation of momentum parallel and perpendicular to the direction of incidence (3 equations total, see lecture notes). One can go through a page of algebra to get the following expression for the energy of projectile $\left(\mathrm{M}_{1}\right)$ after collision:

$$
E_{1}=E_{0}\left[\frac{\left(M_{2}^{2}-M_{1}^{2} \sin ^{2} \theta\right)^{1 / 2}+M_{1} \cos \theta}{M_{2}+M_{1}}\right]^{2}
$$

(a) Assuming that $\mathrm{M}_{1}<\mathrm{M}_{2}$, find the ration of $\frac{E_{1}}{E_{0}}$ at direct backscattering condition $\left(\theta=180^{\circ}\right)$.

Show the details of your calculations.

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(b) Assuming collision where $\mathrm{M}_{1}=\mathrm{M}_{2}$, and the incident particle is at rest after the collision, with all the energy transferred to the target atom, a feature well known in billiards. Find the ration of $\frac{E_{2}}{E_{0}}$ as a function of $\mathrm{M}_{1}, \mathrm{M}_{2}$ and angle $\phi$.
(c) Under which conditions the maximum value of $\frac{E_{2}}{E_{0}}$ (or the maximum energy transfer)?
(d) If you use alpha particles ( $\mathrm{M}_{1}=4$ a.m.u.) with incident energy $\mathrm{E}_{0}=2 \mathrm{MeV}$, detector is at $\theta=180^{\circ}$; and your target is $\sim 100 \AA$ thick gold film on top of silicon substrate), find your energy positions of Si and Au elements in Rutherford Backscattering spectrum. Draw RBS spectrum schematically but mark energy positions for all observed features.
3. (3 points) Silicon nanocrystals (Si-ncs) embedded in $\mathrm{SiO}_{2}$ exhibit strong luminescence at room temperature and are of interest in the drive to produce silicon photonic devices that are compatible with silicon processing techniques. Formation of $\mathrm{Si}-\mathrm{ncs}$ can be done using ion implantation of excess silicon into $\mathrm{SiO}_{2}$ film, followed by high temperature annealing (nucleation and growth via Ostwald ripening).
(a) Your sample is composed of 100 nm SiO 2 film on top of $\mathrm{Si}(001)$ substrate. Use SRIM to find the incident energy of Si ions to place excess Si atoms in the middle of $\mathrm{SiO}_{2}$ layer (assume that implantation angle is 10 degrees).
(b) To achieve excess silicon in $\mathrm{SiO}_{2}$ layer, one has to use implantation dose as high as $1 \mathrm{E} 10^{17} \mathrm{Si}$ atoms $/ \mathrm{cm}^{2}$. As a result of $\mathrm{Si}-\mathrm{ncs}$ formation, $\mathrm{SiO}_{2}$ layer expands or "swells", because of this effect thickness of $\mathrm{SiO}_{2}$ layer becomes larger. Calculate this increase in $\mathrm{SiO}_{2}$ layer thickness, assuming a simplified model when $100 \%$ of implanted Si form Si-ncs that are cubic in shape with the dimensions $d=3 \times$ lattice constant of $\operatorname{Si}\left(a_{\mathrm{Si}}\right)$. As a reminder, Si has a diamond lattice structure with the lattice constant $a=5.43 \AA$ ). (Hint: you may choose to calculate (i) number of Si atoms in unit cell; (ii) how many Si atoms per $\mathrm{cm}^{-3}$.)
(c) During implantation process, some fraction of Si and O atoms will be sputtered. Use SRIM to estimate the total sputtering effect by running SRIM simulation with 1000 incident ions, writing down sputtering yield of Si and O , and extrapolating to the dose of $1 \mathrm{E} 10^{17} \mathrm{Si}$ atoms.
(d) Compare your sputtering results in (c) with "swelling" results in (b), and comment on whether you should use your ion energy for the Si-ncs formation.
4. (2 points) In your own words explain the meanings of matrix effects in SIMS.
5. (3 points) (a) When measuring spherical particles of less than 10 nm on a substrate with an atomic force microscope, an experienced operator uses the height of the sphere to estimate the size of the object. Explain why, instead of using the measured lateral dimension (size) of the sphere, he/she selects to do so.
(b) Explain why phase shift imaging in AFM may be useful in differentiating composite materials. Hint: Think about AFM tip as of a forced oscillator.

